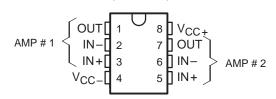
- Matched Gain and Offset Between Amplifiers
- Unity-Gain Bandwidth . . . 3 MHz Min
- Slew Rate . . . 1.5 V/ns Min
- Low Equivalent Input Noise Voltage
 2 μV/Hz Max (20 Hz to 20 kHz)
- No Frequency Compensation Required
- No Latch Up
- Wide Common-Mode Voltage Range
- Low Power Consumption
- Designed to be Interchangeable with Raytheon RC4559

AVAILABLE OPTIONS

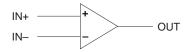
SYMBO	LIZATION	OPERATING	V- mov		
DEVICE	PACKAGE SUFFIX	TEMPERATURE RANGE	V _{IO} max at 25°C		
RC4559	D, P	−0°C to 70°C	6 mV		

The D packages are available taped and reeled. Add the suffix R to the device type when ordering. (i.e.,RC4559DR)

D OR P PACKAGE (TOP VIEW)



symbol (each amplifier)



description

The RC4559 is a dual high-performance operational amplifier. The high common-mode input voltage and the absence of latch-up make this amplifier ideal for low-noise signal applications such as audio preamplifiers and signal conditioners. This amplifier features a guaranteed dynamic performance and output drive capability that far exceeds that of the general-purpose type amplifiers.

The RC4559 is characterized for operation from 0°C to 70°C.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage V _{CC+} (see Note 1)	V
Supply voltage V _{CC} (see Note 1)	V
Differential input voltage (see Note 2) ±30	V
Input voltage (any input, see Notes 1 and 3) ±15	V
Duration of output short-circuit to ground, one amplifier at a time (see Note 4) unlimited	ed
Continuous total dissipation	W
Operating free-air temperature range	°C
Storage temperature range –65°C to 125°	°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	°C

- NOTES: 1. All voltage values, unless otherwise noted, are with respect to the zero reference level (ground) of the supply voltages where the zero reference level is the midpoint between V_{CC+} and V_{CC-}.
 - 2. Differential voltages are at the noninverting input terminal with respect to the inverting input terminal.
 - 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 volts, whichever is less.
 - 4. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.



1

RC4559 DUAL HIGH-PERFORMANCE OPERATIONAL AMPLIFIER

electrical characteristics at specified free-air temperature, $V_{CC+} = 15 \text{ V}$, $V_{CC-} = -15 \text{ V}$

PARAMETER		TEST CONDITIONS†	T _A ‡	MIN	TYP	MAX	UNIT	
.,	Langet affect well- we	\/ O	25°C		2	6	mV	
VIO	Input offset voltage	VO = 0	Full Range			7.5	IIIV	
lio	long to effect ourrent	V- 0	25°C		5	100	nA	
lio	Input offset current	VO = 0	Full range			200		
lini	nput bias current	V _O = 0	25°C		40	250	nA	
IIBI	riput bias current	νO = 0	Full range			500	11/4	
VI	Input voltage range		25°C	±12	±13		V	
		$R_L \ge 3 k\Omega$	25°C	±12	±13			
VOM	Maximum peak output voltlage swing	$R_L = 600 \Omega$	25°C	±9.5	±10		\ \ \	
		$R_L \ge 2 k\Omega$	Full range	±10				
		$V_0 = \pm 10 \text{ V},$	25°C	20	300		.,, ,,	
VI	Input voltage range	$R_L = 2 k\Omega$	Full range	15			V/mV	
BOM	Maximum output-swing bandwidth	$V_{OPP} = 20 \text{ V},$ $R_L = 2 \text{ k}\Omega$	25°C	24	32		kHz	
B ₁	Unity-gain bandwidth		25°C	3	4		MHz	
rį	Input resistance		25°C	0.3	1		MΩ	
CMRR	Common-mode rejection ratio	VO = 0	25°C	80	100		dB	
ksvs	Supply voltage sensitivity (ΔV _{IO} /ΔV _{CC})	V _O = 0	25°C		10	75	μV/V	
V _n	Equivalent input noise voltage (closed loop)	$A_{VD} = 100,$ $R_{S} = 1 \text{ k}\Omega,$ f = 20 Hz to 20 kHz	25°C		1.4	2	μV	
In	Equivalent input noise current	f = 20 Hz to 20 kHz	25°C		25		рΑ	
			25°C		3.3	5.6		
ICC	Supply current (both amplifiers)	No load, No signal	0°C		4	6.6	mA	
			70°C		3	5		
V ₀₁ /V ₀₂	Crosstalk attentuation	$A_{VD} = 100,$ $R_{S} = 1 \text{ k}\Omega,$ f = 10 kHz	25°C		90		dB	

[†] All characteristics are specified under open-loop operation, unless otherwise noted.

matching characteristics at V_{CC+} = 15 V, V_{CC-} = -15 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
VIO	Input offset voltage	VO = 0	±0.2		mV
IIO	Input offset current	V _O = 0	±7.5		nA
I _{IB}	Input bias current	V _O = 0	±15		nA
AVD	Large-signal differential voltage amplification	$V_O = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$	±1		dB

operating characteristics, V_{CC+} = 15 V, V_{CC-} = -15 V, T_A = 25°C

PARAMETER		-	MIN	TYP	MAX	UNIT		
t _r	Rise time	V _I = 20 mV,	$R_L = 2 k\Omega$,	C _L = 100 pF		80		μs
	Overshoot					18%		
SR	Slew rate at unity gain	$V_{I} = 10 \text{ mV},$	$R_L = 2 k\Omega$,	C _L = 100 pF	1.5	2		V/μs



[‡] Full range operating free-air temperature range is 0°C to 70°C.



PACKAGE OPTION ADDENDUM

4-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
RC4559D	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
RC4559DR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
RC4559P	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (**RoHS**): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

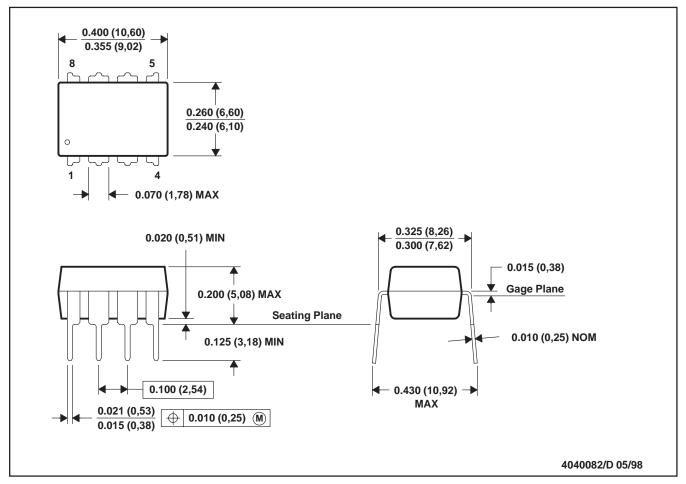
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



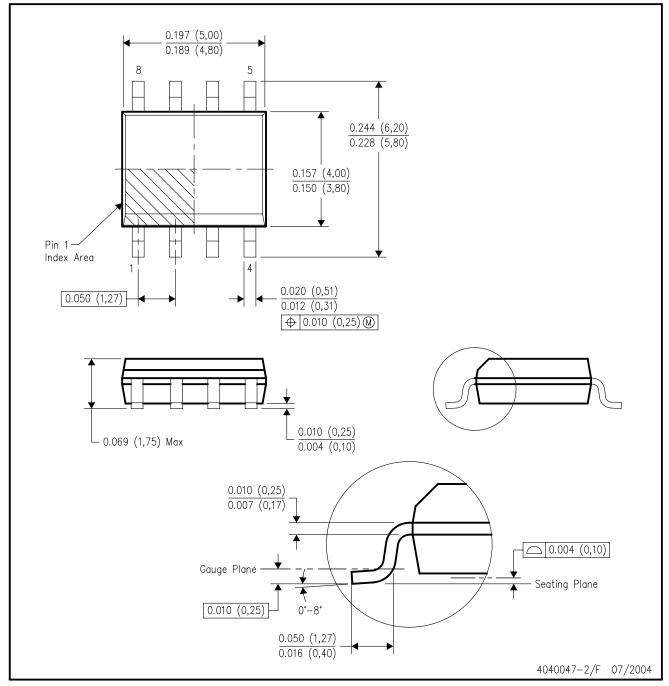
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



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